UVEPROM AS27C256A

Austin Semiconductor, Inc.

256K UVEPROM

UV Erasable Programmable Read-Only Memory

AVAILABLE AS MILITARY SPECIFICATIONS

- -55C to 125C operation
- MILITARY Processing Methods
- Commercial Version Available

FEATURES

- Organized 32,768 x 8
- Single $+5V \pm 10\%$ power supply
- Pin-compatible with existing 256K ROM's and EPROM's
- All inputs/outputs fully TTL compatible
- Power-saving CMOS technology
- Very high-speed FLASHRITE Pulse Programming
- 3-state output buffers
- 400-mV DC assured noise immunity with standard TTL
- Latchup immunity of 250 mA on all input and output pins
- Low power dissipation (CMOS Input Levels)
 - -Active 165mW Worst Case
 - -Standby 1.7mW Worst Case (CMOS-input levels)
- * FUTURE High Speed Offerings: 55ns, 70ns, 90ns

OPTIONS MARKING

Timing	
120ns access	-12
150ns access	-15
170ns access	-17
200ns access	-20
250ns access	-25

Package(s)

Ceramic DIP (600mils)	J	No.	110
Ceramic LCC (450 x 550 mils)	ECA	No.	208

Operating Temperature Ranges

Military	(-55°	C to +1	25°C)	M
Industri	al (-4	0°C to +	-85°C)	I

• Processing Ranges

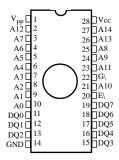
Military 883 Non-Compliant Equivalent /MIL Commercial

For more products and information please visit our web site at www.austinsemiconductor.com

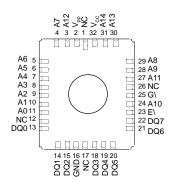
PIN ASSIGNMENT

(Top View)

28-Pin DIP (J) (600 MIL)



32-Pin LCC (ECA) (450 x 550 mils)



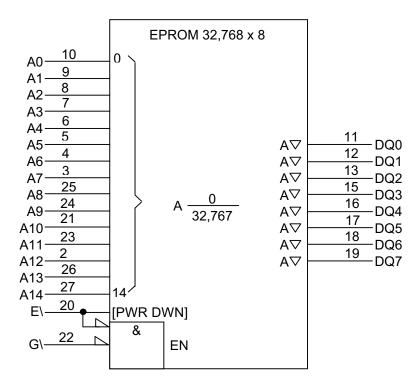
Pin Name	Function
A0 - A14	Address Inputs
DQ0-DQ7	Inputs (programming)/Outputs
E١	Chip Enable/Power Down
G\	Output Enable
GND	Ground
V _{CC}	5V Supply
V _{PP}	13V Programming Power Supply

GENERAL DESCRIPTION

The AS27C256A series is a set of 262,144 bit, ultraviolet-light erasable, electrically programmable read-only memories. These devices are fabricated using power-saving CMOS technology for high speed and simple interface with MOS and bipolar circuits. All inputs (including program data inputs) can be driven by Series 54 TTL circuits without the use of external pullup resistors. Each output can drive one Series 54 TTL circuit without external resistors. The data outputs are 3-state for connecting multiple devices to a common bus. The AS27C256A is pin-compatible with 28-pin 256K ROMs and EPROMs. It is offered in a 600mil dual-in-line ceramic package (J suffix) and a 450 x 550 mil ceramic LCC (ECA suffix) rated for operation from -55°C to 125°C.

Because this EPROM operates from a single 5V supply (in the read mode), it is ideal for use in microprocessor-based systems. One other supply (12.75V) is needed for programming. All programming signals are TTL level. This device is programmable by the AMD FLASHRITE Pulse programming algorithm. The FLASHRITE Pulse programming algorithm uses a $V_{\rm PP}$ of 12.75VV and a $V_{\rm CC}$ of 6.25V for a nominal programming time of four seconds. For programming outside the system, existing EPROM programmers can be used. Locations can be

FUNCTIONAL BLOCK DIAGRAM*



^{*} This symbol is in accordance with ANSI/IEEE std 91-1984 and IEC Publication 617-12.

OPERATION

The seven modes of operation for the AS27C256A are listed in Table 1. The read mode requires a single 5V supply. All inputs are TTL level except for V_{pp} during programming (12.75V for FLASHRITE Pulse), and (12V) on A9 for signature mode.

TABLE 1. OPERATION MODES

FUNCTION				MODE ³	*			
(PINS)	READ	OUTPUT DISABLE	STANDBY	PROGRAMMING	VERIFY	PROGRAM INHIBIT	SIGNATU	RE MODE
E١	V_{IL}	V_{IL}	V_{IH}	V_{IL}	V_{IH}	V_{IH}	V	, IL
G\	V_{IL}	V _{IH}	Х	V_{IH}	V_{IL}	Х	V	, IL
V_{PP}	X ¹	X ¹	X ¹	V_{PP}	V_{PP}	V_{PP}	V	CC
V _{CC}	V _{CC}	V _{CC}	V _{CC} +/3V	V _{CC}	V _{CC}	V _{CC}	V	CC
A9	Х	Х	Х	×	X	Х	V_{ID}^{2}	V_{ID}^{2}
A0	Х	Х	Х	X	Х	Х	V _{IL}	V _{IH}
							COI	DE**
DQ0-DQ7	Data Out	High-Z	High-Z	Data In	Data Out	High-Z	MFG	DEVICE
							01h	10h

¹For normal standby & read operation, VPP is Don't Care X.

NOTES:

 $^{^{2}}$ V_{ID} = 12V +/- .5V

^{*} X can be $V_{\rm IL}$ or $V_{\rm IH}$

^{**} Die is AMD. User can program on benchtop programmer by selecting AM27C256 from the device type selection menu.

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READ/OUTPUT DISABLE

When the outputs of two or more AS27C256A are connected in parallel on the same bus, the output of any particular device in the circuit can be read with no interference from the competing outputs of the other devices. To read the output of the selected AS27C256A, a low-level signal is applied to E\ and G\. All other devices in the circuit should have their outputs disabled by applying a high-level signal to one of these pins. Output data is accessed at pins DQ0 through DQ7.

LATCHUP IMMUNITY

Latchup immunity on the AS27C256A is a minimum of 250mA on all inputs and outputs. This feature provides latchup immunity beyond any potential transients at the printed circuit board level when the EPROM is interfaced to industry standard TTL or MOS logic devices. Input/output layout approach controls latchup without compromising performance or packing density.

POWER DOWN

Active I_{CC} supply current can be reduced from 25mA (AS27C256A-12 through AS27C256A-25) to 1mA (TTL-level inputs) or 300 μ A (CMOS-level inputs) by applying a high TTL/CMOS signal to the $E\$ pin. In this mode all outputs are in the high-impedance state.

ERASURE

Before programming, the AS27C256A is erased by exposing the chip through the transparent lid to a high-intensity ultraviolet light (wavelength 2537 Å). EPROM erasure before programming is necessary to ensure that all bits are in the logichigh state. Logic-lows are programmed into the desired locations. A programmed logic-low can be erased only by ultraviolet light. The recommended minimum exposure dose (UV intensity x exposure time) is 15W•s/cm². A typical 12mW/cm², filterless UV lamp erases the device in 21 minutes. The lamp should be located about 2.5cm above the chip during erasure. After erasure, all bits are in the high state. It should be noted that normal ambient light contains the correct wavelength for erasure; therefore, when using the AS27C256A, the window should be covered with an opaque label.

FLASHRITE PULSE PROGRAMMING

The AS27C256A EPROM is programmed by using the AMD FLASHRITE Pulse programming algorithm as illustrated by the flowchart in Figure 1. This algorithm programs the device in a nominal time of 4 seconds. Actual programming time varies as a function of the programmer used.

Data is presented in parallel (eight bits) on pins DQ0 to DQ7. Once addresses and data are stable, E\ is pulsed.

The FLASHRITE Pulse programming algorithm uses initial pulses of 100 microseconds (µs) followed by a byte-verification step to determine when the addressed byte has been successfully programmed. Up to 25 100µs pulses per byte are provided before a failure is recognized.

The programming mode is achieved when $V_{pp} = 12.75V$, $V_{CC} = 6.25V$, $G \setminus = V_{IH}$, and $E \setminus = V_{IL}$. More than one device can be programmed when the devices are connected in parallel. Locations can be programmed in any order. When the AMD FLASHRITE Pulse programming routine is completed, all bits are verified with $V_{CC} = V_{pp} = 5V$.

PROGRAM INHIBIT

Programming can be inhibited by maintaining a high-level input on $E\$.

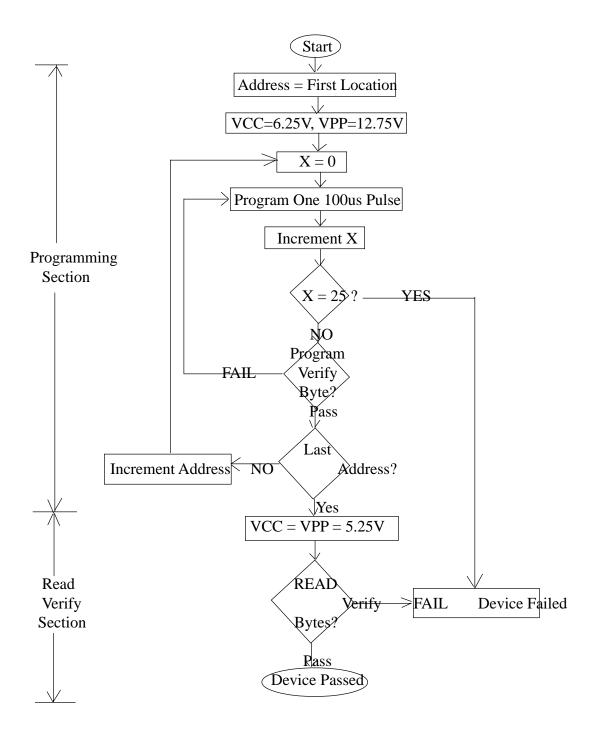
PROGRAM VERIFY

Programmed bits can be verified with $V_{pp} = 12.75V$ when $G \setminus V_{II}$, and $E \setminus V_{IH}$.

SIGNATURE MODE

The signature mode provides access to a binary code identifying the manufacturer and device type. This mode is activated when A9 is forced to $12V\pm0.5V$. Two identifier bytes are accessed by A0 (terminal 10); i.e., $A0=V_{IL}$ accesses the manufacturer code, which is output on DQ0-DQ7; $A0=V_{IH}$ accesses the device code, which is also output on DQ0-DQ7. All other addresses must be held at VIL. Each byte contains odd parity on bit DQ7. The manufacturer code for these devices is 01h and the device code is 10h.

FIGURE 1. FLASHRITE PULSE PROGRAMMING FLOWCHART





UVEPROM AS27C256A

ABSOLUTE MAXIMUM RATINGS*

Supply Voltage Range, V _{CC} **0.6V to +7.0V
Supply Voltage Range, V _{pp} **0.6V to +13.5
Input Voltage Range, All inputs except A9**0.6V to +6.0V
A9 -0.6 V to $+13.5$ V
Output Voltage Range**0.6V to V_{CC} +.6V
Minimum Operating Free-air Temperature, T _A 55°C
Maximum Operating Case Temperature, T _C 125°C
Storage Temperature Range, T65°C to 150°C

*Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is 5 vs stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

** All voltage values are with respect to GND.

RECOMMENDED OPERATING CONDITIONS

				MIN	TYP	MAX
V _{CC}	V _{CC} Supply Voltage Read Mode ¹		4.5	5	5.5	
• 66	Cupply Vollage	FLASHRITE Pulse program	ming algorithm	6	6.25	6.5
V _{PP}	Supply Voltage	Read Mode ²				V _{CC} -0.6
FF	- при, тенаде	FLASHRITE Pulse program	nming algorithm	12.5	12.75	13
V	/ _{IH} High-level input voltage		TTL inputs	2.2		V _{CC} +.6
VIH			CMOS inputs	V _{CC} -0.2		V _{CC} +.6
V _{IL}	Low-level input vol	tage	TTL inputs	-0.5		8.0
V IL	Low-level lilput voi	lage	CMOS inputs	-0.5		0.2
V_{ID}	V _{ID} Voltage level on A9 for signature mode			11.5	12	12.5
T _A	T _A Operating free-air temperature		-55			
T _C	Operating case ter	mperature				+125

NOTES:

ELECTRICAL CHARACTERISTICS OVER RECOMMENDED RANGES OF SUPPLY VOLTAGE AND OPERATING FREE-AIR TEMPERATURE

PARAMETER		TEST CONDITIONS	MIN	TYP ¹	MAX	UNIT	
V_{OH}	High-level output voltage		I _{OH} = -400μA	2.4			٧
V _{OL}	Low-level output voltage		I _{OL} = 2.1mA			0.4	V
I _I	Input current (leakage)		V _I = 0V to 5.5V			±1	μA
Ιο	Output current (leakage)		V _O = 0V to V _{CC}			±5	μA
I _{PP1}	V _{PP} supply current		V _{PP} = V _{CC} = 5.5V			100	μA
I _{PP2}	V _{PP} supply current (during program pulse) ²		V _{PP} = 13V		30	50	mA
-	V aupply aurrent (atandby)	TTL-Input Level	V _{CC} = 5.5V, E\=V _{IH}			1	mA
I _{CC1}	V _{CC} supply current (standby)	CMOS-Input Level	V_{CC} = 5.5V, E\= V_{CC}			300	μA
I _{CC2}	V _{CC} supply current (active)	'27C256-12 '27C256-15 '27C256-17 '27C256-20,-25	$E = V_{IL}, V_{CC} = 5.5V$ $t_{cycle} = minimum, outputs$ open		15	25	mA
		•					

NOTES:

^{1.} V_{CC} must be applied before or at the same time as V_{pp} and removed after or at the same time as V_{pp} . The deivce must not be inserted into or removed from the board when V_{pp} or V_{CC} is applied.

^{2.} V_{pp} can be connected to V_{CC} directly (except in the program mode). V_{CC} supply current in this case would be $I_{CC2} + I_{pp_1}$.

^{1.} Typical values are at T_A =25°C and nominal voltages.

^{2.} This parameter has been characterized at 25°C and is not tested.

CAPACITANCE OVER RECOMMENDED RANGES OF SUPPLY VOLTAGE AND OPERAT-ING FREE-AIR TEMPERATURE, f = 1MHz*

P	ARAMETER	TEST CONDITIONS	TYP**	MAX	UNIT
C _i	Input capacitance	V _I = 0V	6	10	pF
Co	Output capacitance	V _O = 0V	10	14	pF

^{*} Capacitance measurements are made on a sample basis only.

SWITCHING CHARACTERISTICS OVER RECOMMENDED RANGES OF SUPPLY VOLTAGE AND OPERATING FREE-AIR TEMPERATURE^{1,2}

PARAMETER		TEST		-12		-15	
		CONDITIONS ^{1, 2}	MIN	MAX	MIN	MAX	UNIT
t _{a(A)}	Access time from address			120		150	ns
t _{a(E)}	Access time from E\			120		150	ns
t _{en(G)R}	Output enable time from G\			40		50	ns
t _{dis}	Disable time of output from G\ or E whichever occurs first ³	see Figure 2	0	30	0	30	ns
t _{v(A)}	Output data valid time after change of address, E or G whichever occurs first ³		0		0		ns

	DADAMETED		-17		-20		-25		UNIT
PARAMETER		CONDITIONS ^{1, 2}	MIN	MAX	MIN	MAX	MIN	MAX	UNIT
t _{a(A)}	Access time from address			170		200		250	ns
t _{a(E)}	Access time from E\			170		200		250	ns
t _{en(G)R}	Output enable time from G\	F: 0		50		60		60	ns
t _{dis}	Disable time of output from G\ or E whichever occurs first ³	see Figure 2	0	40	0	50	0	60	ns
t _{v(A)}	Output data valid time after change of address, E or G whichever occurs first ³		0		0		0		ns

NOTES:

SWITCHING CHARACTERISTICS FOR PROGRAMMING: $V_{cc} = 6.5V$ and $V_{pp} = 12.75V$ (AMD FLASHRITE ALGO), $T_{\Delta} = 25^{\circ}C$

	PARAMETER	MIN	MAX	UNIT
t _{dis(G)}	Output disable time from G\	0	130	ns
t _{en(G)W}	Output enable time from G\		150	ns

^{**} Typical values are at $T_A = 25^{\circ}$ C and nominal voltages.

^{1.} Timing measurements are made at 2V for logic high and 0.8V for logic low (see figure 2).

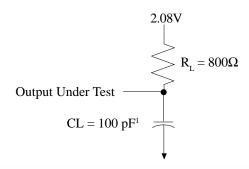
^{2.} Common test conditions apply for $\mathbf{t}_{\mathrm{dis}}$ except during programming.

^{3.} Value calculated from 0.5V delta to measured output level. This parameter is only sampled and not 100% tested.

RECOMMENDED TIMING REQUIREMENTS FOR PROGRAMMING: V_{CC} = 6.5 and V_{PP} = 12.75V (AMD FLASHRITE ALGO), $T_A = 25$ °C (See Figure 2)

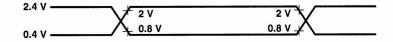
		MIN	TYP	MAX	UNIT
t _{h(A)}	Hold Time, Address	0			μs
t _{h(D)}	Hold Time, Data	2			μs
t _{w(E)PR}	Pulse Duration, Initial Program	95	100	105	μs
t _{su(A)}	Setup Time, Address	2			μs
t _{su(G)}	Setup Time, G\	2			μs
t _{su(E)}	Setup Time, E\	2			μs
t _{su(D)}	Setup Time, Data	2			μs
t _{su(VPP)}	Setup Time, V _{PP}	2			μs
t _{su(VCC)}	Setup Time, V _{CC}	2			μs

PARAMETER MEASUREMENT INFORMATION



NOTES:

1. C_L includes probe and fixture capacitance.



The AC testing inputs are driven at 2.4V for logic high and 0.4V for logic low. Timing measurements are made at 2V for logic high and 0.8V for logic low for both inputs and outputs.

FIGURE 2. LOAD CIRCUIT AND VOLTAGE WAVEFORMS

FIGURE 3. READ-CYCLE TIMING

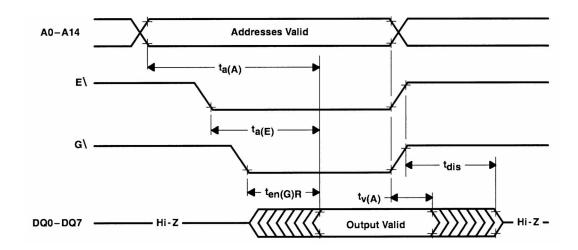
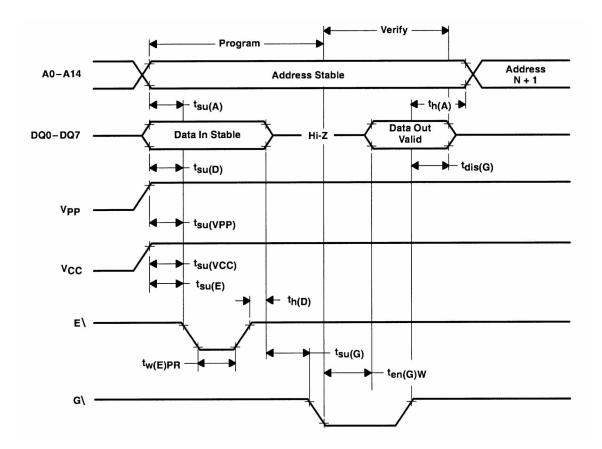
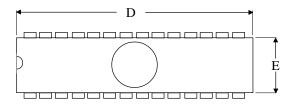


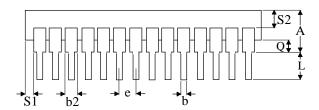
FIGURE 4. PROGRAM-CYCLE TIMING (FLASHRITE PULSE PROGRAMMING)

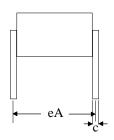


MECHANICAL DEFINITION*

ASI Case #110 (Package Designator J)



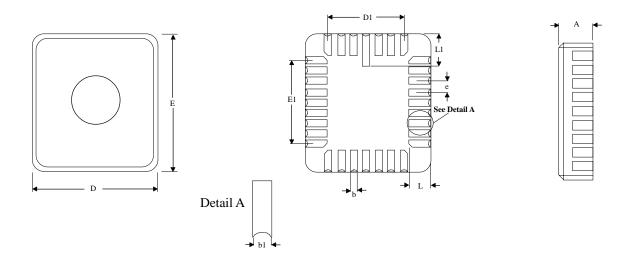




	SMD SPECIFICATIONS		
SYMBOL	MIN	MAX	
Α		0.232	
b	0.014	0.026	
b2	0.045	0.065	
С	0.008	0.018	
D		1.490	
E	0.500	0.610	
eA	0.600) BSC	
е	0.100) BSC	
L	0.125	0.200	
Q	0.015	0.060	
S1	0.005		
S2	0.005		

MECHANICAL DEFINITIONS*

ASI Case #208 (Package Designator ECA)



	SMD SPECIFICATIONS		
SYMBOL	MIN	MAX	
Α	0.060	0.120	
b	0.022	0.028	
b1	0.006	0.022	
D	0.442	0.458	
D1	0.300	BSC	
E	0.540	0.560	
E1	0.400	BSC	
е	0.050	BSC	
L	0.045	0.055	
L1	0.075	0.095	

ORDERING INFORMATION

EXAMPLE: AS27C256A-30JM/MIL

Device Number	Speed	Package Type	Operating Temp.	Available Processes
AS27C256A	-55	J	*	note 1
AS27C256A	-70	J	*	note 1
AS27C256A	-90	J	*	note 1
AS27C256A	-12	J	*	note 1
AS27C256A	-15	J	*	note 1
AS27C256A	-17	J	*	note 1
AS27C256A	-20	J	*	note 1
AS27C256A	-25	J	*	note 1

EXAMPLE: AS27C256A-15ECAM

Device Number	Speed	Package Type	Operating Temp.	Available Processes	
AS27C256A	-55	ECA	*	note 1	
AS27C256A	-70	ECA	*	note 1	
AS27C256A	-90	ECA	*	note 1	
AS27C256A	-12	ECA	*	note 1	
AS27C256A	-15	ECA	*	note 1	
AS27C256A	-17	ECA	*	note 1	
AS27C256A	-20	ECA	*	note 1	
AS27C256A	-25	ECA	*	note 1	

***OPERATING TEMPERATURE**

M = Extended Temperature Range -55°C to +125°C I = Industrial Temperature Range -40°C to +85°C

Note 1: AVAILABLE PROCESSES

/MIL = Denotes MIL-STD-883C process methods used but non-compliant to para

1.2.1.

Blank = Denotes commercial process

ASI TO MIL Process PART NUMBER Examples

ASI Package Designator J

ASI Part #	ASI MIL Process part#
AS27C256A-12JM	AS27C256A-12JM/MIL
AS27C256A-15JM	AS27C256A-15JM/MIL
AS27C256A-17JM	AS27C256A-17JM/MIL
AS27C256A-20JM	AS27C256A-20JM/MIL
AS27C256A-25JM	AS27C256A-25JM/MIL

ASI Package Designator ECA

ASI Part #	ASI MIL Process part#
AS27C256A-12ECAM	AS27C256A-12ECAM/MIL
AS27C256A-15ECAM	AS27C256A-15ECAM/MIL
AS27C256A-17ECAM	AS27C256A-17ECAM/MIL
AS27C256A-20ECAM	AS27C256A-20ECAM/MIL
AS27C256A-25ECAM	AS27C256A-25ECAM/MIL